

LFCV-3002+

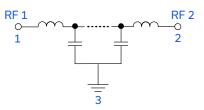
THE BIG DEAL

- Stopband Rejection, Typ. 35 dB
- Low Insertion Loss, Typ. 2.8 dB
- Passband Return Loss, Typ. 11 dB
- Rugged Ceramic Construction
- Small Size, 1210 Surface Mount Footprint



Generic photo used for illustration purposes only

FUNCTIONAL DIAGRAM



APPLICATIONS

- Communications
- Radar, EW, and ECM Defense Systems
- Test & Measurement Equipment

PRODUCT OVERVIEW

Mini-Circuits' LFCV-3002+ is a miniature low-temperature co-fired ceramic (LTCC) low pass filter with a DC to 30 GHz passband that supports a variety of applications. Due to its rugged monolithic construction, this model provides a 2.8 dB typical insertion loss over a wide band. Housed in a small 1210 ceramic form factor, the filter is ideal for dense signal chain PCB layouts where it complements MMIC size and performance. The LTCC fabrication process assures minimal RF performance variation while delivering a product that is well-suited for environmental extremes of high humidity and temperature.

KEY FEATURES

Feature	Advantages
Ultra-wide Stopband	Provides excellent stopband rejection to 67 GHz and beyond, suitable for wideband applications.
LTCC Construction	The use of LTCC technology allows for repeatable performance in a rugged ceramic package, well suited for tough environments such as high humidity and temperature extremes. See Mini-Circuits Environmental Rating ENV06T10 for more information
Excellent Performance for Size	Offers best-in-class performance relative to larger-size alternative technologies. This mmWave multi-layer sur- face mount LTCC filter in a 1210 package allows for space to be saved in dense circuit board layouts, while also minimizing the effects of parasitics.





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ELECTRICAL SPECIFICATIONS^{1,2,3} AT 25°C

F	Parameter	F#	Frequency (GHz)	Min.	Тур.	Max.	Units
	Insertion Loss	DC - F1	DC - 30	_	2.8	4.1	
Passband	Freq. Cut-Off ⁴	Fc	32.2	_	3	_	dB
	Return Loss	DC - F1	DC - 30	_	11	_	
Stopband	Rejection	F2 - F3	40 - 53	25	35	_	-10
		F3 - F4	53 - 67	20	25	_	dB

1. Tested on Evaluation Board P/N TB-LFCV-3002C+ with the connector and feedline effects de-embedded using the 2X Thru IEEE P370 method. 2. Bi-directional, RF1 and RF2 ports can be interchanged.

3. In applications where DC voltage and/or current are present at either the input or output ports, external DC-blocking capacitors are required.

4. Typical variation ±3%.

ABSOLUTE MAXIMUM RATINGS⁵

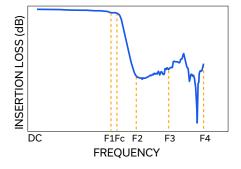
Parameter	Ratings
Operating Temperature	-55°C to +125°C
Storage Temperature	-55°C to +125°C
RF Power Input ⁶	1 W

5. Permanent damage may occur if any of these limits are exceeded.

6. Power rating applies only to signals within the passband. Power rating above

+25°C operating temperature decreases linearly to 0.5 W at +125°C.

TYPICAL FREQUENCY RESPONSE AT 25°C

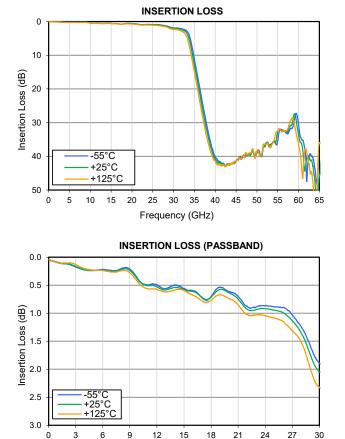


LTCC SURFACE MOUNT LOW Pass Filter 50Ω DC to 30 GHz

LFCV-3002+

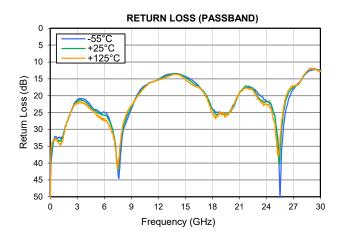
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TYPICAL PERFORMANCE GRAPHS



Frequency (GHz)





LTCC SURFACE MOUNT ow Pass Filter DC to 30 GHz 50Ω

LFCV-3002+

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FUNCTIONAL DIAGRAM

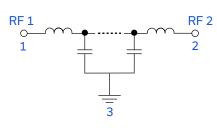
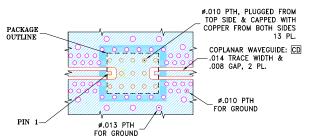


Figure 1. LFCV-3002+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description
RF1 ²	1	Connects to RF Input Port
RF2 ²	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-743)

SUGGESTED PCB LAYOUT (PL-743)



STACK-UP DIAGRAM

	-COPPER LAYER 1(L1), .5 OZ.
РТН	CORE 1, .0079 MECTRON-7 R5785(N/GN)
	PREPREG, 0035 (89um) MEGTRON-7 R5680(N/GN), CLOTH STYLE:1078 PREPREG, 0035 (89um) MEGTRON-7 R5680(N/GN), CLOTH STYLE:1078 COPPER LAVER 3 (L3), 5 0Z.
	CORE 2, .0079 MEGTRON-7 R5785(N/GN)
	-COPPER LAYER 4 (L4), .5 OZ.

1. TOTAL FINISHED THICKNESS 0.026 \pm 10%. 2. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4. 3. INDICATED ON TOP VIEW PTH'S ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE. 4. L2, L3 AND L4 ARE CONTINUOUS GROUND PLANES.

NOTES:

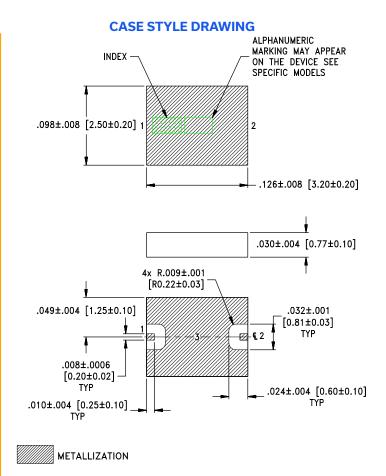
- I. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
 I. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON-7 R-5785(N/GN), WITH DIELECTRIC THICKNESS .0079; COPPER: 1/2 OZ.
 FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Figure 2. Suggested PCB Layout PL-743



Weight: .024 grams Dimensions are in inches [mm]. Tolerances:2 Pl.±.010; 3 Pl. ±.005

PRODUCT MARKING*: ZA

*Marking may contain other features or characters for internal lot control.





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ADDITIONAL INFORMATION IS AVAILABLE ON OUR DASHBOARD

Data Performance Data & Graphs Graphs S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads Case Style JV1210C-13 Lead Finish: Gold over Nickel Plating. **RoHS Status** Compliant F74 Tape and Reel Suggested Layout for PCB Design PL-743 TB-LFCV-3002C+ **Evaluation Board** Gerber File **Environmental Ratings** ENV06T10

CLICK HERE

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

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